

BAW/SAW duplexer for small cell LTE band 7

Series/type: B8032

Ordering code: B39262B8032P810

Date: March 23, 2016

Version: 2.1

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BAW/SAW duplexer for small cell

2535/ 2655 MHz

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1 Application

- Low-loss BAW/SAW hybrid duplexer for LTE smallcell systems (Band 7)
- Low insertion attenuation
- High power durability
- Industrial qualification
- Usable pass band 70 MHz
- Rx = Uplink = 2500-2570 MHz
- Tx = Downlink = 2620-2690 MHz

2 Features

- Package size 2.5±0.1 mm × 2.0±0.1 mm
- Package height 0.5 mm (max.)
- Approximate weight 8 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)



Figure 1: Picture of component with example of product marking.

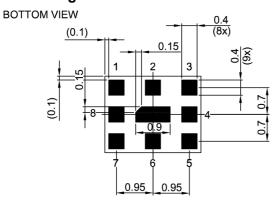


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3 Package



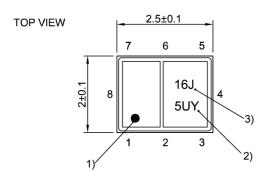
Pad and pitch tolerance ±0.05

Pin configuration

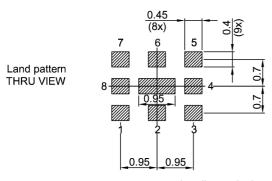
- 1 TX
- 3 RX
- 6 ANT
- 2, Ground 4, 5,
 - 7, 8, 9

SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number



Landing pad tolerance -0.02

Figure 2: Drawing of package with package height A = 0.5 mm (max.). See Sec. Package information (p. 23).



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5 Matching circuit

■ $L_{p1} = 4.7 \text{ nH}$

■ $L_{p6} = 2.2 \text{ nH}$

■ $L_{p3} = 4.3 \text{ nH}$

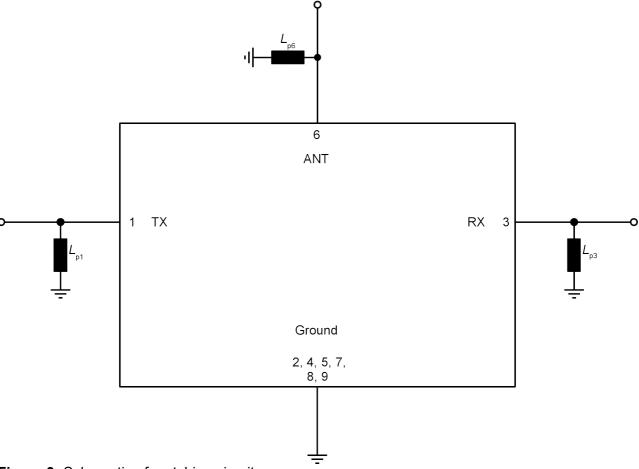


Figure 3: Schematic of matching circuit.



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6 Characteristics

6.1 TX - ANT

Temperature range for specification $T_{\rm SPEC} = -10~{\rm ^{\circ}C}~...~+85~{\rm ^{\circ}C}$ TX terminating impedance $Z_{\rm TX} = 50~\Omega$ with par. 4.7 nH¹⁾ ANT terminating impedance $Z_{\rm ANT} = 50~\Omega$ with par. 2.2 nH¹⁾ RX terminating impedance $Z_{\rm RX} = 50~\Omega$ with par. 4.3 nH¹⁾

Characteristics TX – ANT				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @+25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency			f _C	_	2655	_	MHz
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	2620 2690	MHz		<u> </u>	2.0	3.0	dB
Amplitude ripple (p-p)			Δα				
	2620 2690	MHz		-	0.4	1.5	dB
Maximum VSWR			$VSWR_{max}$				
@ TX port	2620 2690	MHz		l –	1.4	2.0	
@ ANT port	2620 2690	MHz		_	1.4	2.0	
Average error vector magnitude			$EVM_{avg}^{2)}$				
	2622.4 2687.6	MHz		_	1.1	2.0	%
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	10 1710	MHz		30	38	_	dB
	1710 1785	MHz		35	37	_	dB
	1920 1980	MHz		35	38	_	dB
	2270 2300	MHz		35	38	_	dB
	2300 2400	MHz		35	39	_	dB
	2400 2500	MHz		35	44	_	dB
	2500 2570	MHz		38	43	_	dB
	2770 3200	MHz		38	43	_	dB
	3200 4350	MHz		40	45	_	dB
	4350 6000	MHz		35	40	_	dB

See Sec. Matching circuit (p. 5).

²⁾ Error Vector Magnitude (EVM) based on definition given in 3GPP TS 25.141.



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6.2 ANT - RX

Temperature range for specification $T_{\rm SPEC} = -10~{\rm ^{\circ}C}~...~+85~{\rm ^{\circ}C}$ TX terminating impedance $Z_{\rm TX} = 50~\Omega$ with par. 4.7 nH $^{1)}$ ANT terminating impedance $Z_{\rm ANT} = 50~\Omega$ with par. 2.2 nH $^{1)}$ RX terminating impedance $Z_{\rm RX} = 50~\Omega$ with par. 4.3 nH $^{1)}$

Characteristics ANT – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @+25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Center frequency			f _C	_	2535	_	MHz
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	2500 2570	MHz		_	3.0 ²⁾	4.02)	dB
	2500 2570	MHz		_	3.0	4.5	dB
Amplitude ripple (p-p)			Δα				
	2500 2570	MHz		_	1.4 ²⁾	2.52)	dB
	2500 2570	MHz		_	1.4	3.0	dB
Maximum VSWR			$VSWR_{max}$				
@ ANT port	2500 2570	MHz		l –	1.72)	2.22)	
	2500 2570	MHz		–	1.7	2.3	
@ RX port	2500 2570	MHz		_	1.3	2.0	
Average error vector magnitude			$EVM_{avg}^{}3)}$				
	2502.4 2567.6	MHz	3	_	2.1	3.0	%
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	10 1805	MHz		30	36	_	dB
	1805 1880	MHz		30	35	_	dB
	1880 2110	MHz		30	35	_	dB
	2110 2170	MHz		30	36	_	dB
	2170 2300	MHz		30	36	_	dB
	2300 2400	MHz		30	40	_	dB
Channel 1-10	2400 2468	MHz		35	40	_	dB
Channel 11	2462	MHz		254)	434)	_	dB
	2620 2690	MHz		48	54	_	dB
	2690 4050	MHz		25	33	_	dB
	4050 4350	MHz		20	25	_	dB
	4350 4900	MHz		25	30	_	dB
	4900 5091	MHz		26	30	_	dB
	5091 5350	MHz		22	26	_	dB
	5350 6000	MHz		29	32		dB

¹⁾ See Sec. Matching circuit (p. 5).

²⁾ Over temperature range +25°C to +85°C.

³⁾ Error Vector Magnitude (EVM) based on definition given in 3GPP TS 25.141.

⁴⁾ Average attenuation in WLAN channel 11 by integration over 18MHz from 2453 MHz to 2471 MHz.



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6.3 TX – RX

Temperature range for specification $T_{\rm SPEC} = -10~{\rm ^{\circ}C}~...~+85~{\rm ^{\circ}C}$ TX terminating impedance $Z_{\rm TX} = 50~\Omega$ with par. 4.7 nH $^{1)}$ ANT terminating impedance $Z_{\rm ANT} = 50~\Omega$ with par. 2.2 nH $^{1)}$ RX terminating impedance $Z_{\rm RX} = 50~\Omega$ with par. 4.3 nH $^{1)}$

Characteristics TX – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @+25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Minimum isolation		,	$\alpha_{\scriptscriptstyle min}$				
	2500 2570	MHz		38	43	_	dB
	2570 2620	MHz		15	20	_	dB
	2620 2690	MHz		48	58	_	dB

¹⁾ See Sec. Matching circuit (p. 5).



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7 **Maximum ratings**

Storage temperature	T _{STG} = -40 °C +85 °C	
DC voltage	$V_{DC} = 0 \text{ V (max.)}$	
ESD voltage	$V_{ESD} = 50 \text{ V (max.)}^{1)}$	
Input power	P _{IN}	
@ TX port: 2620 2690 MHz	26 dBm	Source and load impedance 50Ω. LTE 5MHz downlink. T=55°C, 100.000hrs. ²⁾
@ TX port: other frequency range(s)	10 dBm	Source and load impedance 50Ω .
Operating lifetime with output power at antenna	P _{OUT}	
@ ANT port: 2620 2690 MHz	22.5 dBm	Continuous wave T= 55 °C, 100.000 hrs. ³⁾

¹⁾ According to JESD22-A115A (machine model), 1 negative and 1 positive pulses.

Time to failure (TTF) according to accelerated power durability tests, and wear out models. According to accelerated high temperature operating life (HOTL) test. 2)

³⁾



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8 Transmission coefficients

8.1 TX – ANT

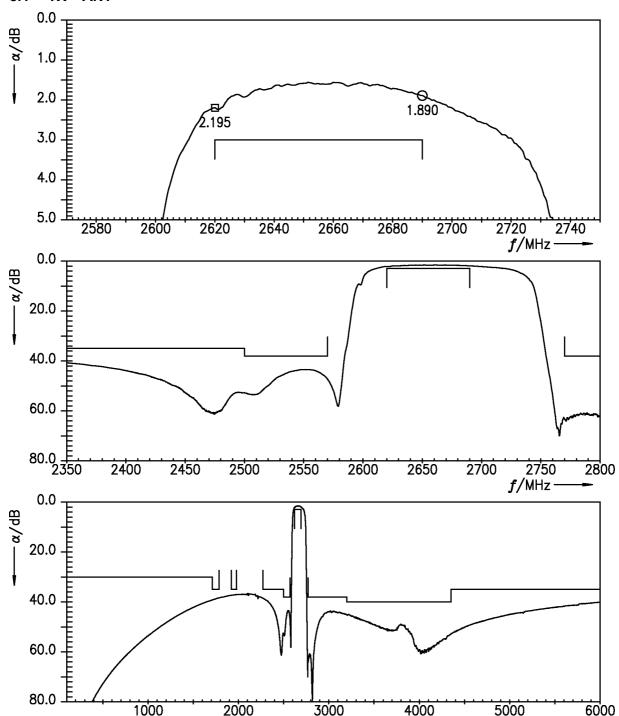


Figure 4: Attenuation TX – ANT.

f/MHz -



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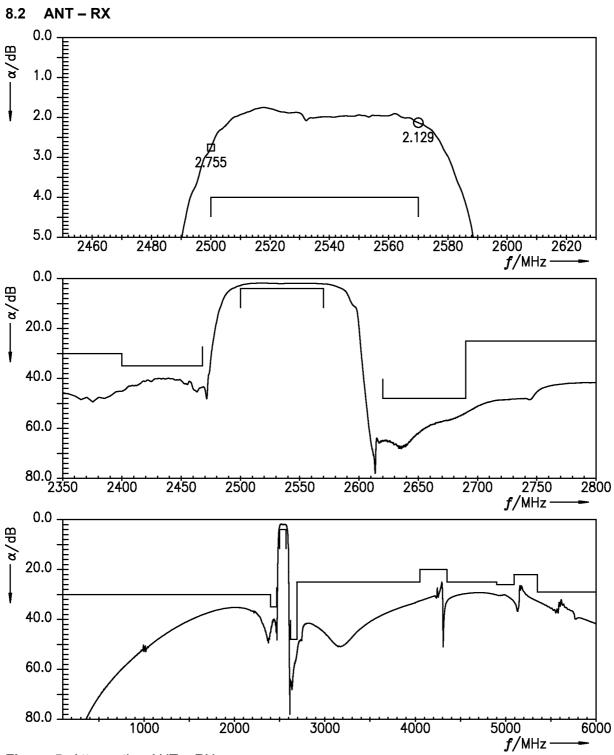


Figure 5: Attenuation ANT – RX.



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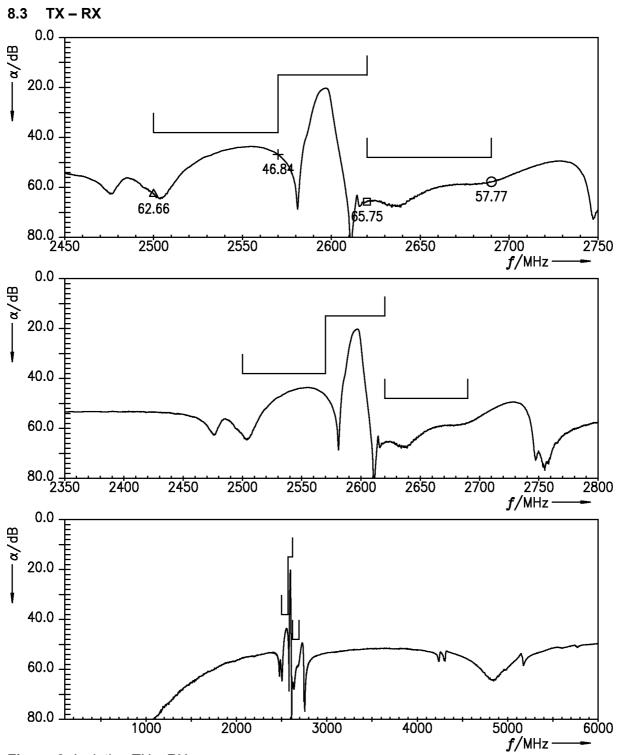


Figure 6: Isolation TX – RX.

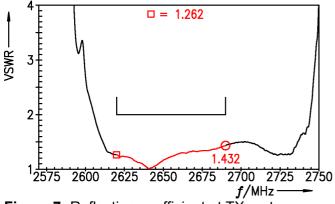


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9 Reflection coefficients



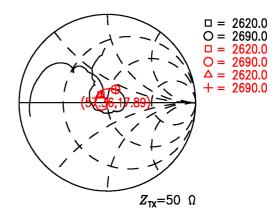
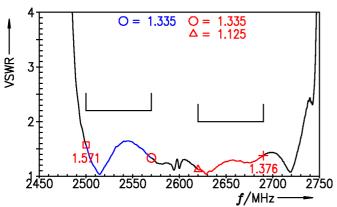


Figure 7: Reflection coefficient at TX port.



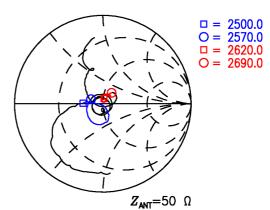
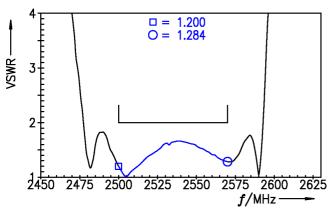


Figure 8: Reflection coefficient at ANT port (TX and RX frequencies).



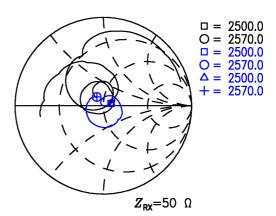


Figure 9: Reflection coefficient at RX port.



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10 EVMs



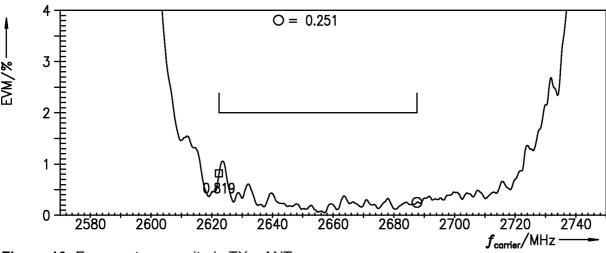


Figure 10: Error vector magnitude TX – ANT.



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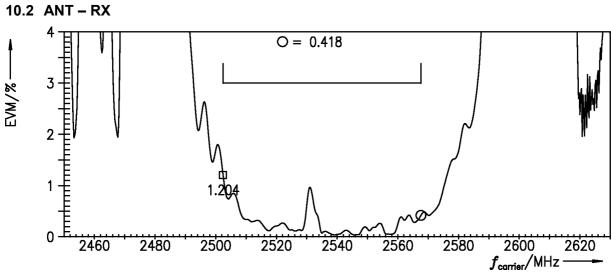


Figure 11: Error vector magnitude ANT – RX.



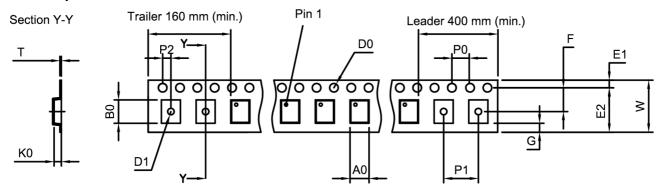
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11 Packing material

11.1 Tape



User direction of unreeling

Figure 12: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A ₀	2.25±0.05 mm	E	6.25 mm (min.)	P ₁	4.0±0.1 mm
B ₀	2.75±0.05 mm	F	3.5 _{±0.05} mm	P_2	2.0±0.05 mm
D ₀	1.5+0.1/-0 mm	G	0.75 mm (min.)	Т	0.25±0.03 mm
D ₁	1.0 mm (min.)	K	0.6±0.05 mm		8.0+0.3/-0.1 mm
E ₁	1.75±0.1 mm	Po	4.0±0.1 mm		

Table 1: Tape dimensions.

11.2 Reel with diameter of 180 mm

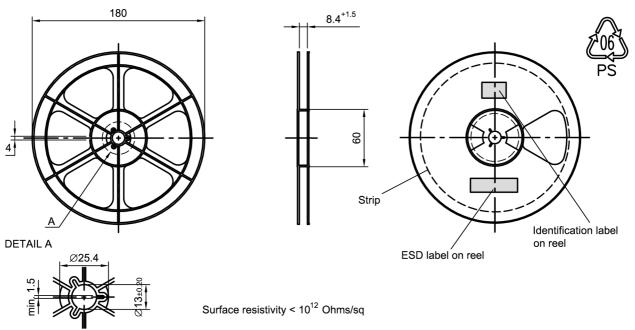


Figure 13: Drawing of reel (first-angle projection) with diameter of 180 mm.



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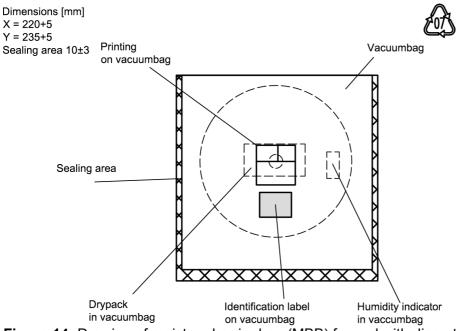


Figure 14: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

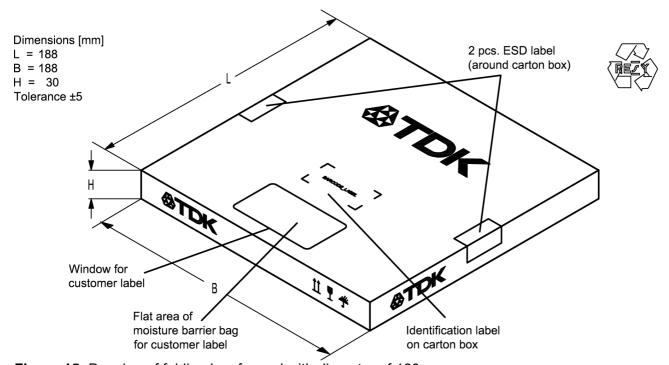


Figure 15: Drawing of folding box for reel with diameter of 180 mm.



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11.3 Reel with diameter of 330 mm

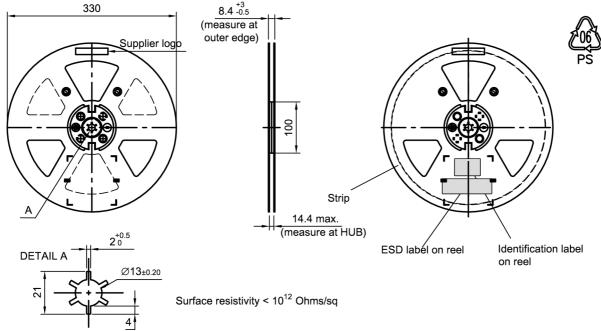


Figure 16: Drawing of reel (first-angle projection) with diameter of 330 mm.

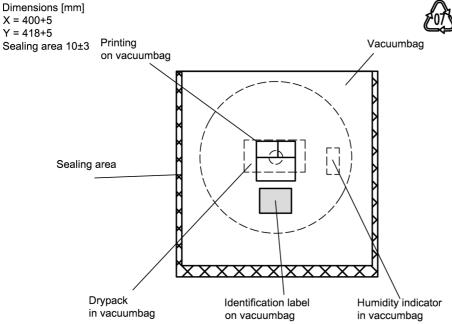


Figure 17: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.



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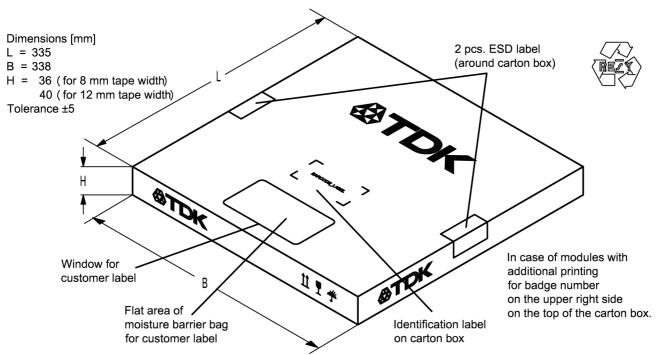


Figure 18: Drawing of folding box for reel with diameter of 330 mm.

12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.

16J => 1234

1 x 32^2 + 6 x 32^1 + 18 (=J) x 32^0 = 1234

The BASE32 code for product type B8032 is 7V0.

■ Lot number:

The last 5 digits of the lot number, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.

5UY => 12345 $5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0 =$ 12345



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Adopted BASE32 code for type number					
Decimal	Base32	Decimal	Base32		
value	code	value	code		
0	0	16	G		
1	1	17	Н		
2	2	18	J		
3	3	19	K		
4	4	20	M		
5	5	21	N		
6	6	22	Р		
7	7	23	Q		
8	8	24	R		
9	9	25	S		
10	Α	26	Т		
11	В	27	V		
12	С	28	W		
13	D	29	X		
14	E	30	Y		
15	F	31	Z		

Adopted BASE47 code for lot number					
Decimal	Base47	Decimal	Base47		
value	code	value	code		
0	0	24	R		
1	1	25	S		
2	2	26	T		
3	3	27	U		
4	4	28	V		
5	5	29	W		
6	6	30	X		
7	7	31	Υ		
8	8	32	Z		
9	9	33	b		
10	Α	34	d		
11	В	35	f		
12	С	36	h		
13	D	37	n		
14	Е	38	r		
15	F	39	t		
16	G	40	V		
17	Н	41	١		
18	J	42	?		
19	K	43	{		
20	L	44	}		
21	M	45	<		
22	N	46	>		
23	Р				

Table 2: Lists for encoding and decoding of marking.



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13 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

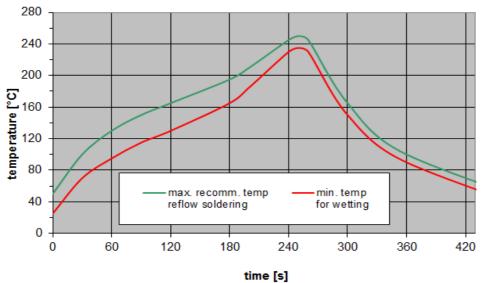


Figure 19: Recommended reflow profile for convection and infrared soldering – lead-free solder.



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14 Annotations

14.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

14.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local EPCOS sales office.

14.4 Ordering codes and packing units

Ordering code	Packing unit
B39262B8032P810	5000 pcs

Table 4: Ordering codes and packing units.



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15 Cautions and warnings

15.1 Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local EPCOS sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on EPCOS internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of EPCOS, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.epcos.com/material). Should you have any more detailed questions, please contact our sales offices.
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